



Model ZOLID.PEBBLE.2

The **ZOLID.PEBBLE.2** model is a resilient ThinClient in an extremely compact design.

Its robust aluminum housing and the serial interfaces make it an **ideal choice for use in industrial environments**. However, it is also perfectly suited for **office use**, thanks to the **three display connections** that offer versatile connection possibilities. In demanding environments, such as in **warehouses or production lines**, the passive cooling technology ensures that dust particles or residues cannot settle in the housing.


The openthinclient® model boots in connection with central administration by the **openthinclient Management Server*** via **network (PXE)**. By using the onboard already integrated SSD, the ThinClient can - after the corresponding configuration in the management software* - **can also be booted locally**.


*ThinClient is delivered without an operating system and management software


Technical specifications

 **CPU**
1.8 GHz Intel® Celeron® J6413


 **RAM**
4 GB, DDR4 SO-DIMM

 **Graphics / display**
Intel® UHD Graphics
10th generation
2x HDMI
1x DP


 **LAN**
2x Ethernet RJ45
10/100/1000 MBit/s
Supports PXE-Boot (UEFI)


 **Audio**
1x Mic-in
1x Line-out


 **Connections**
2x USB (3.0)
2x USB (2.0)
2x COM RS232


 **Intern**
1x mSATA
1x M.2 2280 NVME
1x M.2 2230 WIFI/Bluetooth

 **Power supply**
12V DC-IN

 **Performance**
approx. 5-15 Watts


 **Measurements and weight**
Aluminum housing
135mmx127mmx39mm (LxWxH)
590g


 **Cooling**
Fanless, passively cooled


 **Surroundings**
-20° - 70° Ambient temperature
0% - 95% Humidity


 **Guarantee**
24 months Bring-in (B2B)

 **Certification mark**
CE, RoHS

 **Accessories (included)**
External power supply
VESA mount

 **Accessories (optional)**
Keyboard, mouse
Hardware warranty

 **Recommended thin client software**
openthinclient OS, ab Version 2022.x

 **Note**
Device dissipates the developed heat via the housing. A cover can lead to damage.